



193.04

35.81
182.63

127.76
182.63

162.56
174.50

6.60

73.41
166.12

127.76
144.27

162.56
136.14

35.81
144.27

73.41
127.76

127.76
105.92

162.56
97.79

6.60

35.81
105.92

73.41
89.41

127.76
67.56

162.56
59.44

35.81
67.56

73.41
51.05

127.76
39.62

162.56
15.24

6.60

27.69

65.28
39.62

65.28
27.43

142.24
15.24

163.07
15.24

200.00

200.00

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